



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

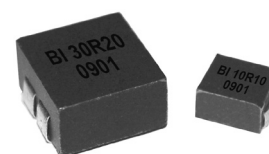


Electrical / Environmental

HM69D

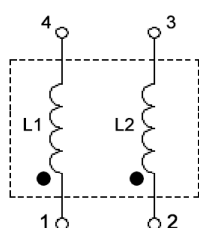
Surface Mount Power Bead Coupled Inductors

- Operating Temperature Range -40°C to +125°C
- Temperature Rise, Maximum 40°C
- Operating Frequency Up to 3MHz

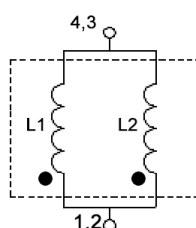


Schematics

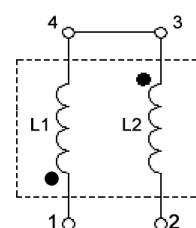
Independent Inductors



Parallel Inductors



Series Inductors



Specifications @ 25°C

Dual Phase Integrated Inductor Specifications (Multi-Phase System⁽¹⁾)

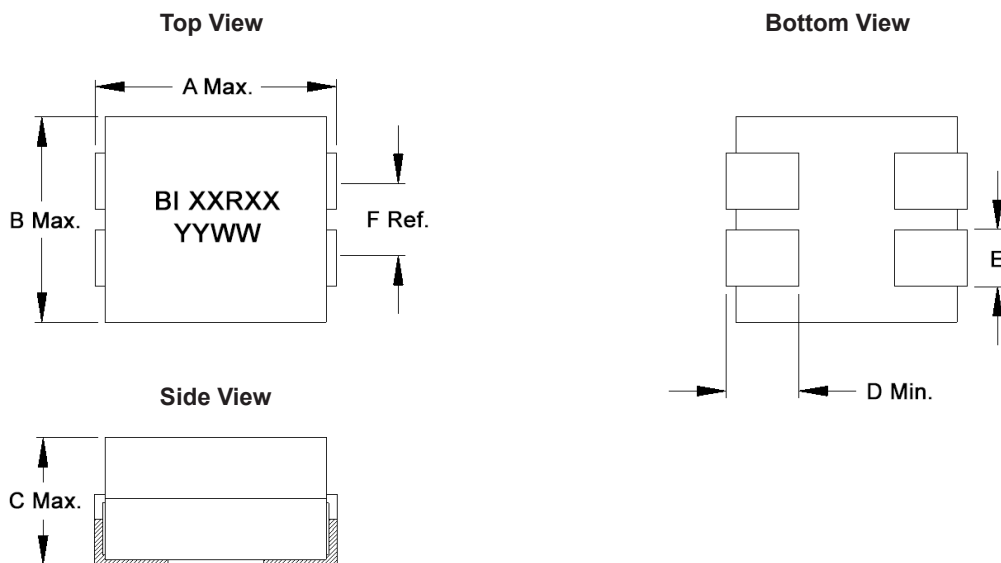
Part Number	Inductance 100kHz, 0.1V				DCR ⁽²⁾ (mΩ Typ.)		I _{rated} ⁽³⁾ @ 25°C (A _{dc})		I _{sat} ⁽⁴⁾ @ 25°C (A _{dc})		Heating ⁽⁵⁾ Current (A _{dc})	
	@ 0 A _{dc} (nH ± 20%)		@ I _{rated} (nH ± 20%)		L1	L2	L1	L2	L1	L2	L1	L2
	L1	L2	L1	L2	L1	L2	L1	L2	L1	L2	L1	L2
HM69D-10R10LF	100	100	90	90	0.67	0.67	35	35	37	37	20	20
HM69D-30R20LF	200	200	180	180	0.43	0.43	24	24	27	27	44	44
HM69D-30R23LF	230	230	207	207	0.43	0.43	22	22	25	25	44	44
HM69D-30R33LF	330	330	297	297	0.43	0.43	17	17	19	19	44	44

Single Phase Inductor Specifications (Parallel & Series Connections⁽¹⁾)

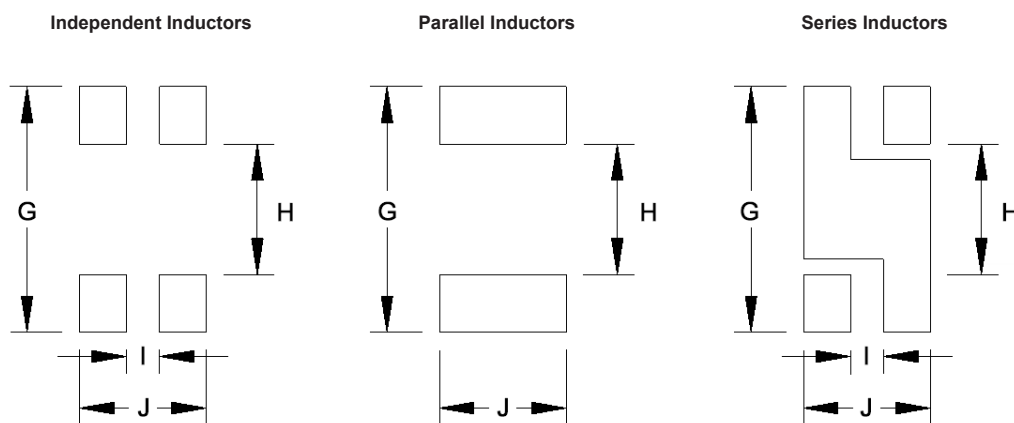
Part Number	Inductance 100kHz, 0.1V		DCR ⁽²⁾ (mΩ Typ.)	I _{rated} ⁽³⁾ @ 25°C (A _{dc})	I _{sat} ⁽⁴⁾ @ 25°C (A _{dc})	Heating ⁽⁵⁾ Current (A _{dc})	Connection
	@ 0 A _{dc} (nH ± 20%)	@ I _{rated} (nH ± 20%)					
HM69D-10R10LF	50	45	0.34	60	62	28	Parallel
HM69D-30R20LF	100	90	0.22	95	105	62	
HM69D-30R23LF	115	103	0.22	81	90	62	
HM69D-30R33LF	165	148	0.22	67	72	62	
HM69D-10R10LF	200	180	1.35	32	34	14	Series
HM69D-30R20LF	400	360	0.90	44	50	30	
HM69D-30R23LF	460	414	0.90	42	47	30	
HM69D-30R33LF	660	594	0.90	36	40	30	

- Notes: (1) The HM69D consists of two separate and independent inductors integrated into a single package. The two inductors can be used for two separate phases within dual output or multi-phase application or they can be connected in series or parallel to form a single inductor within a single phase application.
- (2) The normal DC resistance has a tolerance of $\pm 9\%$. This tolerance is guaranteed by design but is not a manufacturing production test. For production test, a maximum DC resistance value is used.
- (3) The rated current is the current which causes the inductance to drop a maximum of 10% from the nominal inductance @0A at the stated ambient temperature of 25°C. This current is determined by applying a short duration pulse current (to avoid self-heating effects) to the device.
- (4) The saturation current is the current which causes the inductance to drop a maximum of 30% from the nominal inductance @0A at the stated ambient temperature of 25°C. This current is determined by applying a short duration pulse current (to avoid self-heating effects) to the device.
- (5) The heating current to the DC current which causes the component temperature to increase by approximately 40°C. This current is determined by soldering the component on a typical application PCB, and then applying the current to the device for 30 minutes.

Outline Dimensions (mm)



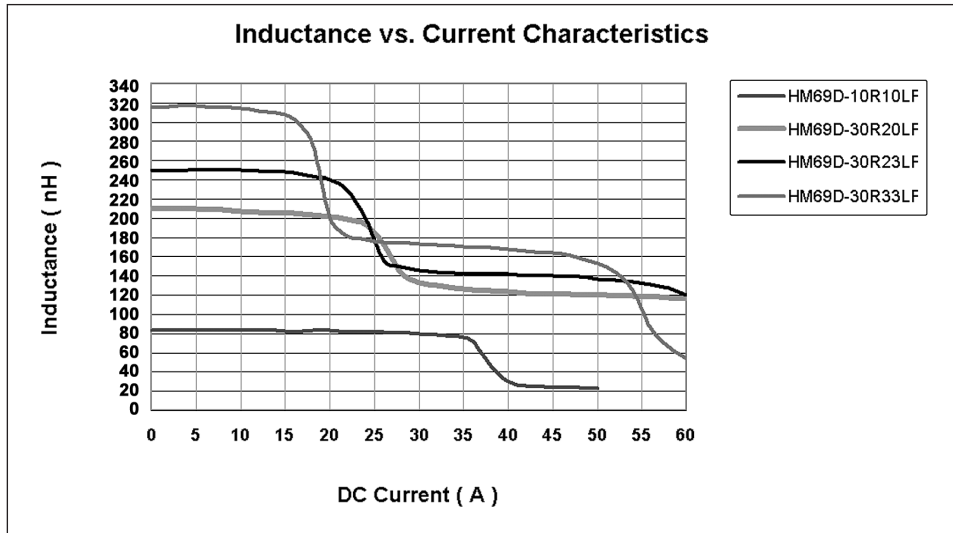
Recommended Solder Pad Layout



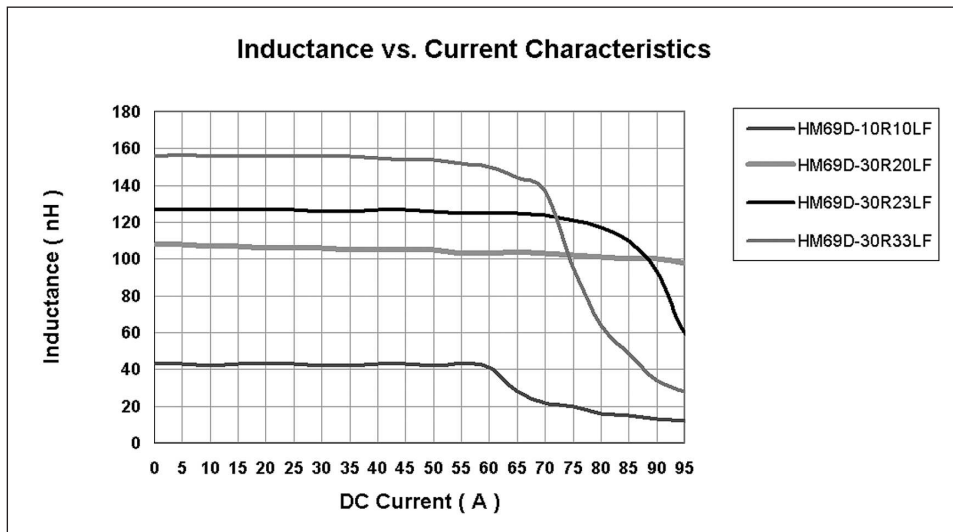
Case Size	A	B	C	D	E	F	G	H	I	J
10	8.20	6.80	4.50	2.50	1.27	2.65	8.80	4.20	1.00	4.00
30	14.00	13.20	7.00	2.50	2.80	4.15	14.60	7.50	2.00	8.00

Electrical Characteristics @ 25°C

(A) Two Independent Inductors

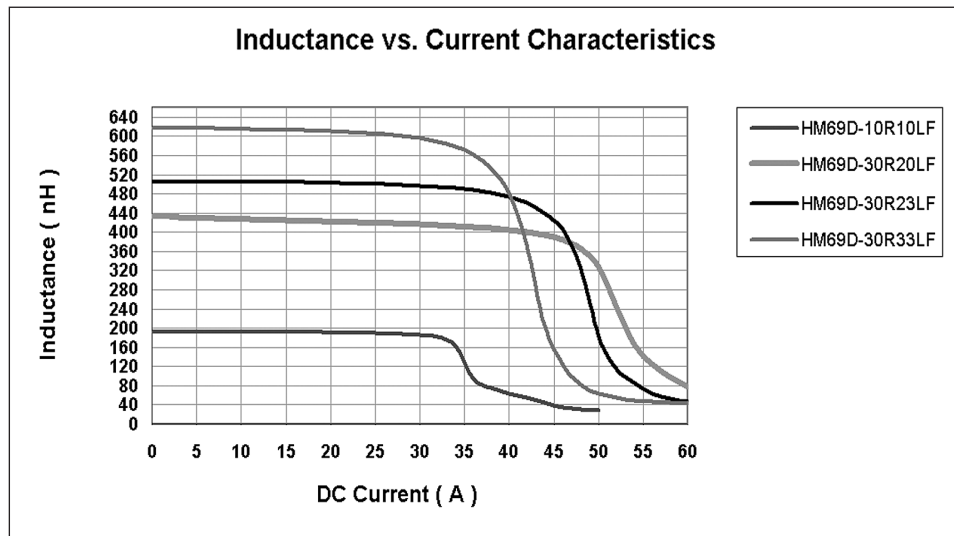


(B) Single Inductor Parallel Connection



Electrical Characteristics @ 25°C (Cont'd)

(C) Single Inductor Series Connection



Packaging

Standard: Embossed Tape & Reel

Reel:	Diameter:	=	13" (330.2mm)
	Capacity:	Case size 10	= 1000 Units
		Case size 30	= 400 Units

Ordering Information

